



Frequency Generator for Pentium™ Based Systems

General Description

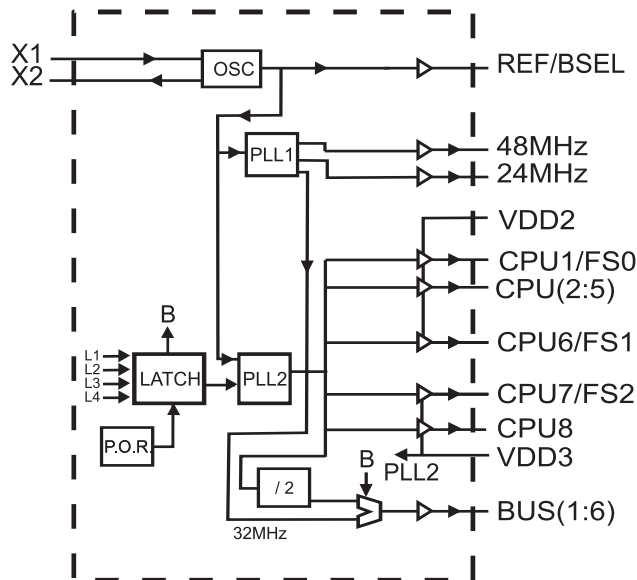
The ICS9169C-23 is a low-cost frequency generator designed specifically for Pentium-based chip set systems. The integrated buffer minimizes skew and provides all the clocks required. A 14.318 MHz crystal provides the reference clock to generate standard Pentium frequencies. The CPU clock makes gradual frequency transitions without violating the PLL timing of internal microprocessor clock multipliers.

Either synchronous (CPU/2) or asynchronous (32 MHz) PCI bus operation can be selected by latching data on BSEL input.

Features

- Eight selectable CPU clocks operate up to 83.3 MHz
- Maximum CPU jitter of ± 200 ps
- Six BUS clocks support sync or async bus operation
- 250ps skew window for CPU outputs, 500ps skew window for BUS outputs
- CPU clocks to BUS clocks skew 1-4 ns (CPU early)
- 48 MHz clock for USB support & 24 MHz clock for FD.
- Logic inputs latched at Power-On for frequency selection saving pins as Input/Output
- Integrated buffer outputs drive up to 30pF loads
- 3.0V - 3.7V supply range, CPU (1:6) outputs 2.5V (2.375 - 2.6V) VDD option
- 28-pin SOIC package

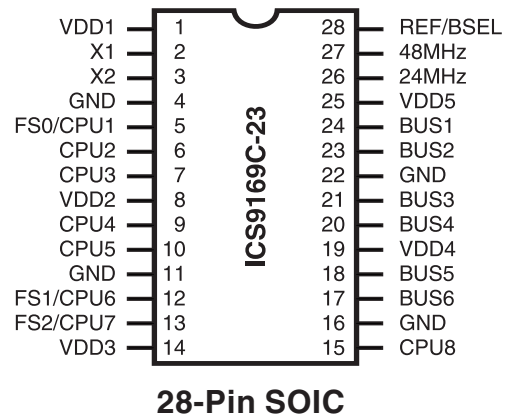
Block Diagram



VDD Groups:
 VDD1 = X1, X2, REF/BSEL
 VDD2 = CPU1-6
 VDD3 = CPU7-8 & PLL Core
 VDD4 = BUS1-6
 VDD5 = 48/24 MHz

Latched Inputs:
 L1 = BSEL
 L2 = FS0
 L3 = FS1
 L4 = FS2

Pin Configuration



28-Pin SOIC

Functionality

3.3V \pm 10%, 0-70°C
 Crystal (X1, X2) = 14.31818 MHz

ADDRESS SELECT			CPU(1:8) (MHz)	BUS (1:6)MHz		48MHz	24MHz	REF
FS2	FS1	FS0		BSEL=1	BSEL=0			
0	0	0	50	25	32	48	24	REF
0	0	1	60	30	32	48	24	REF
0	1	0	66.6	33.3	32	48	24	REF
0	1	1	REF/2	REF/4	REF/3	REF/2	REF/4	REF
1	0	0	55	27.5	32	48	24	REF
1	0	1	75	37.5	32	48	24	REF
1	1	0	83.3	41.7	32	48	24	REF
1	1	1	Tristate	Tristate	Tristate	Tristate	Tristate	Tristate

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Pin Descriptions

PIN NUMBER	PIN NAME	TYPE	DESCRIPTION
1	VDD1	PWR	Power for control logic.
2	X1	IN	XTAL or external reference frequency input. This input includes XTAL load capacitance and feedback bias for a 12-16MHz crystal, nominally 14.31818MHz. External crystal load of 30pF to GND recommended for VDD power on faster than 2.0ms.
3	X2	OUT	XTAL output drive from device. External crystal load of 10pF to GND recommended for VDD power on faster than 2.0ms.
4,11,16,22	GND	PWR	Ground for control logic.
6,7,9,10,15	CPU(2:5),8	OUT	Processor clock outputs which are a multiple of the input reference clock as shown in the preceding table.
8	VDD2	PWR	Power for CPU 1-6 buffers only. This VDD supply can be reduced to 2.5V for CPU (1:6) outputs.
24, 23, 21, 20, 18, 17	BUS(1:6)	OUT	BUS clock outputs which are a multiple of the input reference clock as shown in the preceding table.
19	VDD4	PWR	Power for BUS# fixed mode device.
26	24 MHz	OUT	Fixed 24 MHz clock (assuming a 14.31818 MHz REF frequency).
27	48 MHz	OUT	Fixed 48 MHz clock (assuming a 14.31818 MHz REF frequency).
28	REF	OUT	Fixed 14.31818 MHz clock (assuming a 14.31818 MHz REF frequency).
	BSEL	IN	Selection for synchronous (High) or asynchronous (Low) bus clock operation. See shared pin programming description later in this data sheet for further explanation.
5	CPU 1	OUT	Processor clock outputs which are a multiple of the input reference clock as shown in the preceding table.
	FS0	IN	Frequency multiplier select pins. See shared pin programming description later in this data sheet for further explanation.*
12,13	CPU (6:7)	OUT	Processor clock outputs which are a multiple of the input reference clock as shown in the preceding table.
	FS (1:2)	IN	Frequency multiplier select pins. See shared pin programming description later in this data sheet for further explanation.*
14	VDD3	PWR	Power for CPU7-8 clock buffers and internal PLL and Core logic. Must be nominal 3.3V (3.0 to 3.7V)
25	VDD5	PWR	Power for 24/48 MHz output buffer.

* The internal pull-up will vary from 350K to 500K based on temperature.



Shared Pin Operation - Input/Output Pins

Shared Pin Operation - Input/Output, Pins 5, 28, 12 and 13 on the ICS9169C-23 serve as dual signal functions to the device. During initial power-up, they act as input pins. The logic level (voltage) that is present on these pins at this time is read and stored into a 4-bit internal data latch. At the end of Power-On reset, (see AC characteristics for timing values), the device changes the mode of operations for these pins to an output function. In this mode the pins produce the specified buffered clocks to external loads.

To program (load) the internal configuration register for these pins, a resistor is connected to either the VDD (logic 1) power supply or the GND (logic 0) voltage potential. A 10 Kiloohm(10K) resistor is used to provide both the solid CMOS programming voltage needed during the power-up programming period and to provide an insignificant load on the output clock during the subsequent operating period.

Figs. 1 and 2 show the recommended means of implementing this function. In Fig. 1 either one of the resistors is loaded onto the board (selective stuffing) to configure the device's internal logic. Figs. 2a and b provide a single resistor loading option where either solder spot tabs or a physical jumper header may be used.

These figures illustrate the optimal PCB physical layout options. These configuration resistors are of such a large ohmic value that they do not effect the low impedance clock signals. The layouts have been optimized to provide as little impedance transition to the clock signal as possible, as it passes through the programming resistor pad(s).

Test Mode Operation

The ICS9169C-23 includes a production test verification mode of operation. This requires that the FSO and FS1 pins be programmed to a logic high and the FS2 pin be programmed to a logic low(see Shared Pin Operation section). In this mode the device will output the following frequencies.

Pin	Frequency	
REF	REF	
48MHz	REF/2	
24MHz	REF/4	
CPU (1:8)	REF2	
BUS (1:6)	BSEL=1	REF/4
	BESEL = 0	REF/3

Note: REF is the frequency of either the crystal connected between the devices X1and X2 or, in the case of a device being driven by an external reference clock, the frequency of the reference (or test) clock on the device's X1 pin.

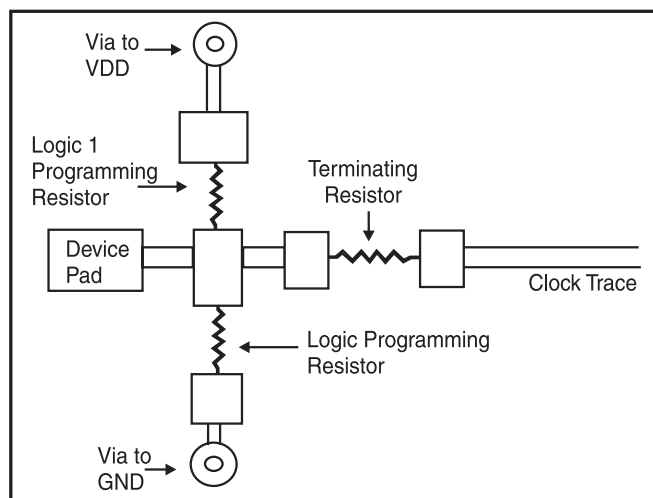


Fig. 1

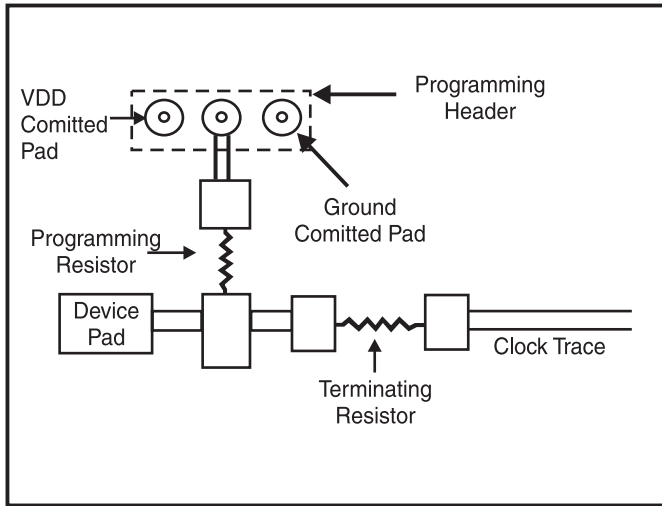


Fig. 2a

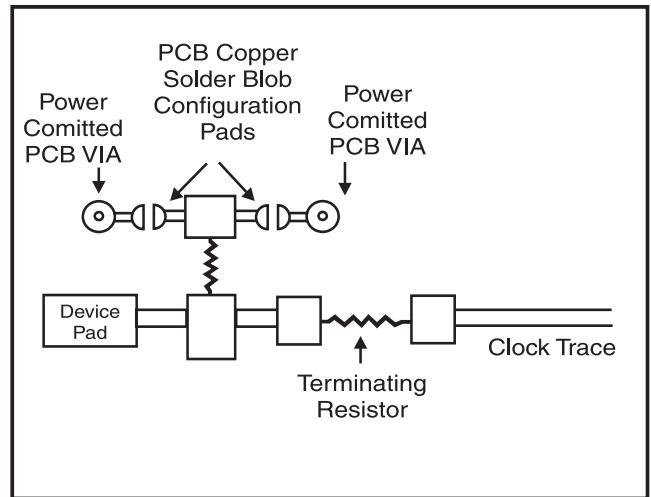


Fig. 2b

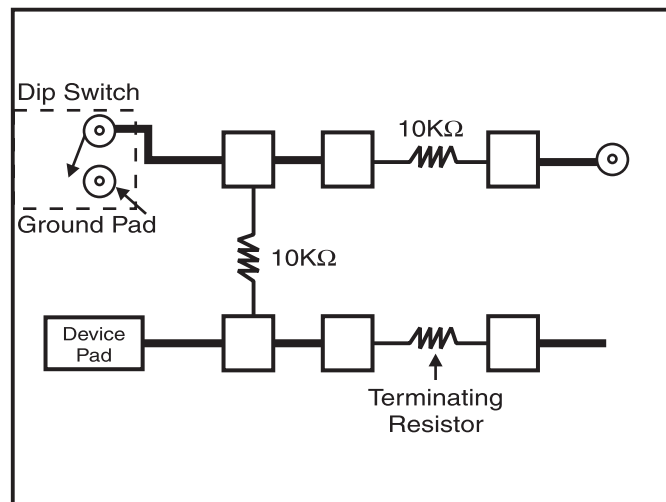


Fig. 3



Technical Pin Function Descriptions

VDD

This is the power supply to the internal logic of the device as well as the following clock output buffers:

- A. REF clock output buffers
- B. BUS clock output buffers
- C. Fixed clock output buffers

This pin may be operated at any voltage between 3.0 and 5.5 volts. Clocks from the listed buffers that it supplies will have a voltage swing from ground to this level. For the actual guaranteed high and low voltage levels of these clocks, please consult the AC parameter table in this data sheet.

GND

This is the power supply ground return pin for the internal logic of the device as well as the following clock output buffers:

- A. REF clock output buffers
- B. BUS clock output buffers
- C. CPU clock output buffers

X1

This pin serves one of two functions. When the device is used with a crystal, X1 acts as the input pin for the reference signal that comes from the discrete crystal. When the device is driven by an external clock signal, X1 is the device' input pin for that reference clock. This pin also implements an internal crystal loading capacitor that is connected to ground. See the data tables for the value of the capacitor.

X2

This pin is used only when the device uses a Crystal as the reference frequency source. In this mode of operation, X2 is an output signal that drives (or excites) the discrete crystal. This pin also implements an internal crystal loading capacitor that is connected to ground. See the data tables for the value of the capacitor.

CPU (1:8)

This pin is the clock output that drives processor and other CPU related circuitry that require clocks which are in tight skew tolerance with the CPU clock. The voltage swing of these clocks is controlled by that which is applied to the VDD pin of the device. See the Functionality table at the beginning of this data sheet for a list of the specific frequencies this clock operates at and the selection codes that are necessary to produce these frequencies.

BUS (1:6)

This pin is the clock output that is intended to drive the systems plug-in card bus. The voltage swing of these

clocks is controlled by the supply that is applied to the VDD pin of the device. See the Functionality table at the beginning of this data sheet for a list of the specific frequencies that this clock operates at and the selection codes that are necessary to produce these frequencies.

FS0, FS1, FS2

These pins control the frequency of the clocks at the CPU, CPUL, BUS, SDRAM, AGP and IOAPIC pins. See the Functionality table at the beginning of this data sheet for a list of the specific frequencies that this clock operates at and the selection codes that are necessary to produce these frequencies. The device reads these pins at power-up and stores the programmed selection code in an internal data latch. (See programming section of this data sheet for configuration circuitry recommendations.)

BSEL

When this pin is a logic 1, it will place the CPU clocks in the synchronous mode (running at half the frequency of the Ref). If this pin is a logic 0, it will be in the asynchronous mode for the CPU clocks and will operate at the preprogrammed fixed frequency rate. It is a shared pin and is programed the same way as the Frequency Select pins.

VDD 2, 3

These are the power supply pins for the CPU clock buffers. By separating the clock power pins, each group can receive the appropriate power decoupling and bypassing necessary to minimize EMI and crosstalk between the individual signals. VDD2 can be reduced to 2.5V VDD for advanced processor clocks, which will bring CPU (1:6) outputs at 0 to 2.5V output swings.

48 MHz

This is a fixed frequency clock that is typically used to drive Super I/O peripheral device needs.

24 MHz

This is a fixed frequency clock that is typically used to drive Keyboard controller clock needs.

VDD4

This power pin supplies the BUS clock buffers.

REF

This is a fixed frequency clock that runs at the same frequency as the input reference clock (typically 14.31818 MHz) is and typically used to drive Video and ISA BUS requirements.

VDD5

This power pin supplies the 48/24 MHz clocks.



Absolute Maximum Ratings

Supply Voltage	7.0 V
Logic Inputs	GND -0.5 V to V _{DD} +0.5 V
Ambient Operating Temperature	0°C to +70°C
Storage Temperature	-65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics at 3.3V

V_{DD} = 3.0 – 3.7 V, T_A = 0 – 70°C unless otherwise stated

DC Characteristics						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Input Low Voltage	V _{IL}		-	-	0.2V _{DD}	V
Input High Voltage	V _{IH}		0.7V _{DD}	-	-	V
Input Low Current	I _{IL}	VIN=0V	-28.0	-10.5	-	μA
Input High Current	I _{IH}	VIN=V _{DD}	-5.0	-	5.0	μA
Output Low Current ¹	I _{OL}	VOL=0.8V; for CPU, BUS, Fixed CLKs	16.0	25.0	-	mA
Output High Current ¹	I _{OH}	VOL=2.0V; for CPU, BUS, Fixed CLKs	-	-30.0	-14.0	mA
Output Low Current ¹	I _{OL}	VOL=0.8V; for Ref CLK	19.0	30.0	-	mA
Output High Current ¹	I _{OH}	VOL=2.0V; for Ref CLK	-	-38.0	-16.0	mA
Output Low Voltage ¹	V _{OL}	IOL=8mA; for CPU, BUS, Fixed CLKs	-	0.3	0.4	V
Output High Voltage ¹	V _{OH}	IOH=-8mA; for CPU, BUS, Fixed CLKs	2.4	2.8	-	V
Output Low Voltage ¹	V _{OL}	IOL=10mA; for Ref CLK	-	0.3	0.4	V
Output High Voltage ¹	V _{OH}	IOH=-15mA; for Ref CLK	2.4	2.8	-	V
Output Current	I _{OC}	IOH=-15mA; for Ref CLK	-	70	140	mA

¹Output Current parameter is guaranteed by design and characterization. Not 100% tested in production.

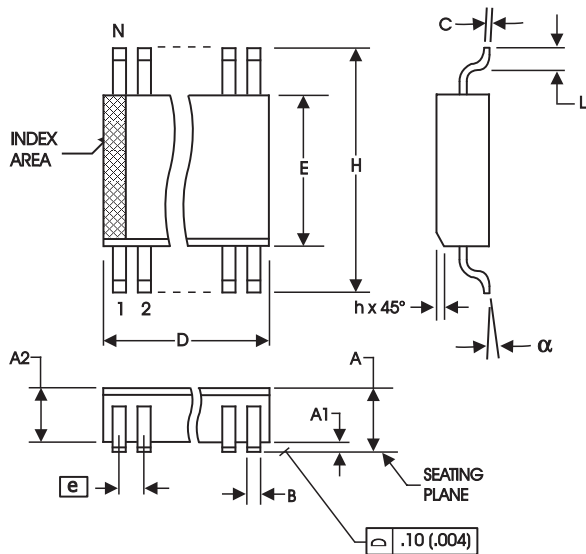


Electrical Characteristics at 3.3V

V_{DD} = 3.0 – 3.7V, T_A = 0 – 70° C unless otherwise stated

AC Characteristics						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Rise Time ¹	Tr1	20pF load, 0.8 to 2.0V CPU & BUS	-	0.9	1.5	ns
Fall Time ¹	Tf1	20pF load, 2.0 to 0.8V CPU & BUS	-	0.8	1.4	ns
Rise Time ¹	Tr2	20pF load, 20% to 80% CPU & BUS	-	1.5	2.5	ns
Fall Time ¹	Tf2	20pF load, 80% to 20% CPU & BUS	-	1.4	2.4	ns
Duty Cycle ¹	Dt	20pF load @ V _{OUT} =1.4V	45	50	60	%
Jitter, One Sigma ¹	Tj1s1	CPU & BUS Clocks; Load=20pF, BSEL=1	-	50	150	ps
Jitter, Absolute ¹	Tjab1	CPU & BUS Clocks; Load=20pF, BSEL=1	-250	-	250	ps
Jitter, One Sigma ¹	Tj1s2	Ref & Fixed CLKs; Load=20pF	-	1	3	%
Jitter, Absolute ¹	Tjab2	Ref & Fixed CLKs; Load=20pF	-5	2	5	%
Input Frequency ¹	Fi		12.0	14.318	16.0	MHz
Logic Input Capacitance ¹	CIN	Logic input pins	-	5	-	pF
Crystal Oscillator Capacitance ¹	CINX	X1, X2 pins	-	18	-	pF
Power-on Time ¹	ton	From V _{DD} =1.6V to 1st crossing of 66.6 MHz V _{DD} supply ramp < 40ms	-	2.5	4.5	ms
Frequency Settling Time ¹	ts	From 1st crossing of acquisition to < 1% settling	-	2.0	4.0	ms
Clock Skew ¹	Tsk1	CPU to CPU; Load=20pF; @ 1.4V	-	150	250	ps
Clock Skew ¹	Tsk2	BUS to BUS; Load=20pF; @ 1.4V	-	160	500	ps
Clock Skew ¹	Tsk3	CPU to BUS; Load=20pF; @ 1.4V (CPU is early)	1	2.2	4	ns

Note 1: Parameter is guaranteed by design and characterization. Not 100% tested in production.



300 mil (Wide Body) SOIC

SYMBOL	In Millimeters		In Inches	
	COMMON DIMENSIONS	COMMON DIMENSIONS	COMMON DIMENSIONS	COMMON DIMENSIONS
	MIN	MAX	MIN	MAX
A	--	2.65	--	.104
A1	0.10	--	.0040	--
A2	2.05	2.55	.081	.100
B	0.33	0.51	.013	.020
C	0.18	0.32	.007	.013
D	SEE VARIATIONS		SEE VARIATIONS	
E	7.40	7.60	.291	.299
e	1.27 BASIC		0.050 BASIC	
H	10.00	10.65	.394	.419
h	0.25	0.75	.010	.029
L	0.40	1.27	.016	.050
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0°	8°

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	17.70	18.40	.697	.724

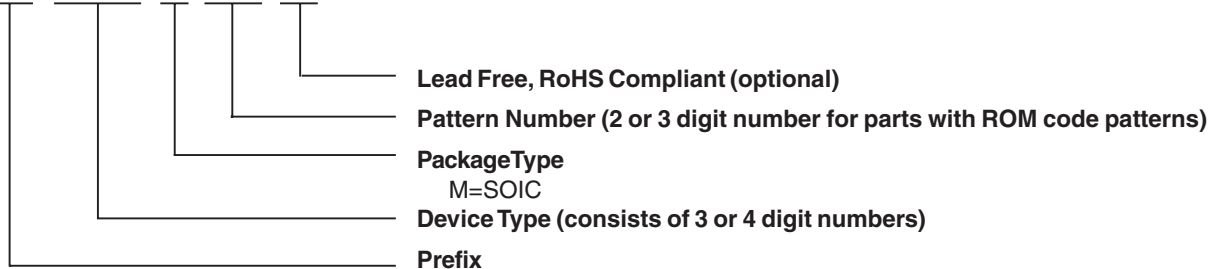
Reference Doc.: JEDEC Publication 95, MS-013 & MO-119
10-0031

Ordering Information

ICS9169CM-23LF

Example:

ICS XXXX M- PPP LF





Revision History

Rev.	Issue Date	Description	Page #
D	3/1/2007	Added LF ordering Information.	8